Product data sheet

1. General description

The 74HC245; 74HCT245 is an 8-bit transceiver with 3-state outputs. The device features an output enable ($\overline{\text{OE}}$) and send/receive (DIR) for direction control. A HIGH on $\overline{\text{OE}}$ causes the outputs to assume a high-impedance OFF-state. Inputs include clamp diodes. This enables the use of current limiting resistors to interface inputs to voltages in excess of V_{CC} .

2. Features and benefits

- Wide supply voltage range from 2.0 V to 6.0 V
- · CMOS low power dissipation
- · High noise immunity
- · Octal bidirectional bus interface
- · Non-inverting 3-state outputs
- Input levels:
 - For 74HC245: CMOS level
 - For 74HCT245: TTL level
- Complies with JEDEC standards
 - JESD8C (2.7 V to 3.6 V)
 - JESD7A (2.0 V to 6.0 V)
- Latch-up performance exceeds 100 mA per JESD 78 Class II Level B
- ESD protection:
 - HBM: ANSI/ESDA/JEDEC JS-001 class 2 exceeds 2000 V
 - CDM: ANSI/ESDA/JEDEC JS-002 class C3 exceeds 1000 V
- Multiple package options
- Specified from -40 °C to +85 °C and from -40 °C to +125 °C

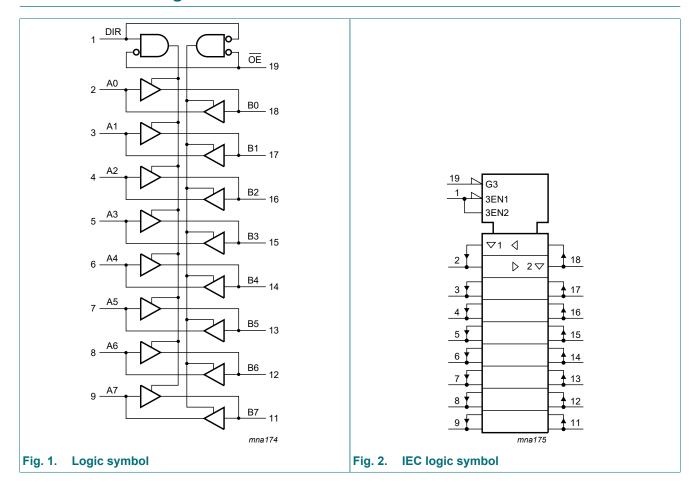
3. Ordering information

Table 1. Ordering information

Type number	Package								
	Temperature range	Name	Description	Version					
74HC245D 74HCT245D	-40 °C to +125 °C	SO20	plastic small outline package; 20 leads; body width 7.5 mm	SOT163-1					
74HC245PW 74HCT245PW	-40 °C to +125 °C	TSSOP20	plastic thin shrink small outline package; 20 leads; body width 4.4 mm	SOT360-1					
74HC245BQ 74HCT245BQ	-40 °C to +125 °C	DHVQFN20	plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 20 terminals; body 2.5 × 4.5 × 0.85 mm	SOT764-1					
74HC245BZ 74HCT245BZ	-40 °C to +125 °C	DHXQFN20	plastic, leadless dual in-line compatible thermal enhanced extreme thin quad flat package; no leads; 20 terminals; 0.4 mm pitch; body 2 mm × 3.2 mm × 0.48 mm	SOT8020-1					

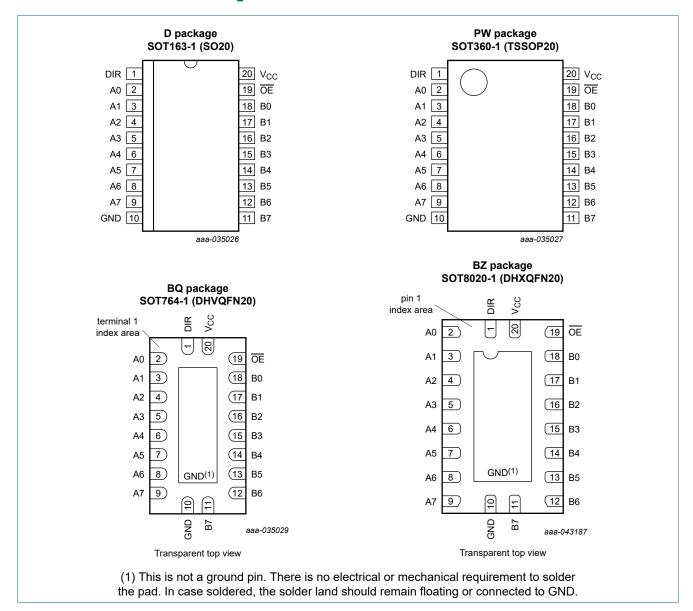


4. Functional diagram



5. Pinning information

5.1. Pinning



5.2. Pin description

Table 2. Pin description

Symbol	Pin	Description
DIR	1	direction control
A0, A1, A2, A3, A4, A5, A6, A7	2, 3, 4, 5, 6, 7, 8, 9	data input/output
GND	10	ground (0 V)
B7, B6, B5, B4, B3, B2, B1, B0	11, 12, 13, 14, 15, 16, 17, 18	data input/output
ŌE	19	output enable input (active LOW)
Vcc	20	supply voltage

6. Functional description

Table 3. Function table

 $H = HIGH \text{ voltage level}; L = LOW \text{ voltage level}; X = don't care; Z = high-impedance OFF-state.}$

Input		Input/output		
ŌE DIR		An	Bn	
L	L	A = B	input	
L	Н	input	B = A	
Н	X	Z	Z	

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		Min	Max	Unit
V _{CC}	supply voltage			-0.5	+7	V
I _{IK}	input clamping current	$V_{I} < -0.5 \text{ V or } V_{I} > V_{CC} + 0.5 \text{ V}$		-	±20	mA
lok	output clamping current	V_{O} < -0.5 V or V_{O} > V_{CC} + 0.5 V		-	±20	mA
Io	output current	$-0.5 \text{ V} < \text{V}_{\text{O}} < \text{V}_{\text{CC}} + 0.5 \text{ V}$		-	±35	mA
Icc	supply current			-	70	mA
I _{GND}	ground current			-70	-	mA
T _{stg}	storage temperature			-65	+150	°C
P _{tot}	total power dissipation	T _{amb} = -40 °C to +125 °C				
		SOT163-1 (SO20) SOT360-1 (TSSOP20) SOT764-1 (DHVQFN20)	[1] [2] [3]	-	500	mW
		SOT8020-1 (DHXQFN20)		-	250	mW

- [1] For SOT163-1 (SO20) package: P_{tot} derates linearly with 12.3 mW/K above 109 °C.
- [2] For SOT360-1 (TSSOP20) package: P_{tot} derates linearly with 10.0 mW/K above 100 °C.
- [3] For SOT764-1 (DHVQFN20) package: Ptot derates linearly with 12.9 mW/K above 111 °C.

8. Recommended operating conditions

Table 5. Recommended operating conditions

Symbol	Parameter	neter Conditions 74HC245			5	74HCT245			
			Min	Тур	Max	Min	Тур	Max	
V _{CC}	supply voltage		2.0	5.0	6.0	4.5	5.0	5.5	V
VI	input voltage		0	-	V _{CC}	0	-	V _{CC}	V
Vo	output voltage		0	-	V _{CC}	0	-	V _{CC}	V
Δt/ΔV	input transition rise and	V _{CC} = 2.0 V	-	-	625	-	-	-	ns/V
	fall rate	V _{CC} = 4.5 V	-	1.67	139	-	1.67	139	ns/V
		V _{CC} = 6.0 V	-	-	83	-	-	-	ns/V
T _{amb}	ambient temperature		-40	+25	+125	-40	+25	+125	°C

9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		25 °C		-40 °C to	o +85 °C	-40 °C to	+125 °C	Unit
			Min	Тур	Max	Min	Max	Min	Max	
74HC24	5								'	1
V _{IH}	HIGH-level	V _{CC} = 2.0 V	1.5	1.2	-	1.5	-	1.5	-	V
	input voltage	V _{CC} = 4.5 V	3.15	2.4	-	3.15	-	3.15	-	V
		V _{CC} = 6.0 V	4.2	3.2	-	4.2	-	4.2	-	V
V _{IL}	LOW-level	V _{CC} = 2.0 V	-	0.8	0.5	-	0.5	-	0.5	V
	input voltage	V _{CC} = 4.5 V	-	2.1	1.35	-	1.35	-	1.35	V
		V _{CC} = 6.0 V	-	2.8	1.8	-	1.8	-	1.8	V
V _{OH}	HIGH-level	V _I = V _{IH} or V _{IL}								
	output voltage	I _O = -20 μA; V _{CC} = 2.0 V	1.9	2.0	-	1.9	-	1.9	-	V
		I _O = -20 μA; V _{CC} = 4.5 V	4.4	4.5	-	4.4	-	4.4	-	V
		I _O = -20 μA; V _{CC} = 6.0 V	5.9	6.0	-	5.9	-	5.9	-	V
		I _O = -6.0 mA; V _{CC} = 4.5 V	3.98	4.32	-	3.84	-	3.7	-	V
		I _O = -7.8 mA; V _{CC} = 6.0 V	5.48	5.81	-	5.34	-	5.2	-	V
V _{OL}	LOW-level	$V_I = V_{IH}$ or V_{IL}								
	output voltage	I _O = 20 μA; V _{CC} = 2.0 V	-	0	0.1	-	0.1	-	0.1	V
		I _O = 20 μA; V _{CC} = 4.5 V	-	0	0.1	-	0.1	-	0.1	V
		I _O = 20 μA; V _{CC} = 6.0 V	-	0	0.1	-	0.1	-	0.1	V
		I _O = 6.0 mA; V _{CC} = 4.5 V	-	0.15	0.26	-	0.33	-	0.4	V
		I _O = 7.8 mA; V _{CC} = 6.0 V	-	0.16	0.26	-	0.33	-	0.4	V
I _I	input leakage current	$V_I = V_{CC}$ or GND; $V_{CC} = 6.0 \text{ V}$	-	-	±0.1	-	±1.0	-	±1.0	μΑ
l _{OZ}	OFF-state output current	$V_I = V_{IH}$ or V_{IL} ; $V_{CC} = 6.0$ V; $V_O = V_{CC}$ or GND	-	-	±0.5	-	±5.0	-	±10	μΑ
I _{CC}	supply current	V _I = V _{CC} or GND; I _O = 0 A; V _{CC} = 6.0 V	-	-	8.0	-	80	-	160	μΑ
C _I	input capacitance		-	3.5	-	-	-	-	-	pF
C _{I/O}	input/output capacitance		-	10	-	-	-	-	-	pF

Symbol	Parameter	Conditions		25 °C		-40 °C t	o +85 °C	-40 °C to +125 °C		Unit
			Min	Тур	Max	Min	Max	Min	Max	
74HCT2	45					l				
V _{IH}	HIGH-level input voltage	V _{CC} = 4.5 V to 5.5 V	2.0	1.6	-	2.0	-	2.0	-	V
V _{IL}	LOW-level input voltage	V _{CC} = 4.5 V to 5.5 V	-	1.2	0.8	-	0.8	-	0.8	V
V _{OH}	HIGH-level	$V_I = V_{IH}$ or V_{IL} ; $V_{CC} = 4.5 \text{ V}$								
	output voltage	Ι _Ο = -20 μΑ	4.4	4.5	-	4.4	-	4.4	-	V
		I _O = -6 mA	3.98	4.32	-	3.84	-	3.7	-	V
V _{OL} LOW-level output voltage		$V_I = V_{IH}$ or V_{IL} ; $V_{CC} = 4.5 \text{ V}$								
	I _O = 20 μA	-	0	0.1	-	0.1	-	0.1	V	
	I _O = 6.0 mA	-	0.15	0.26	-	0.33	-	0.4	V	
l _l	input leakage current	$V_I = V_{CC}$ or GND; $V_{CC} = 5.5 \text{ V}$	-	-	±0.1	-	±1.0	-	±1.0	μΑ
l _{OZ}	OFF-state output current	$V_I = V_{IH}$ or V_{IL} ; $V_{CC} = 5.5$ V; $V_O = V_{CC}$ or GND	-	-	±0.5	-	±5.0	-	±10	μΑ
I _{CC}	supply current	V _I = V _{CC} or GND; V _{CC} = 5.5 V; I _O = 0 A	-	-	8.0	-	80	-	160	μΑ
ΔI _{CC}	additional supply current	$V_I = V_{CC} - 2.1 \text{ V};$ other inputs at V_{CC} or GND; $V_{CC} = 4.5 \text{ V}$ to 5.5 V; $I_O = 0 \text{ A}$								
		An or Bn inputs	-	40	144	-	180	-	196	μΑ
		OE input	-	150	540	-	675	-	735	μΑ
		DIR input	-	90	324	-	405	-	441	μΑ
C _I	input capacitance		-	3.5	-	-	-	-	-	pF
C _{I/O}	input/output capacitance		-	10	-	-	-	-	-	pF

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10. Dynamic characteristics

Table 7. Dynamic characteristics

GND = 0 V; for test circuit see Fig. 5.

Symbol	Parameter	Conditions			25 °C		-40 °C to	o +85 °C	-40 °C to +125 °C		Unit
				Min	Тур	Max	Min	Max	Min	Max	
74HC24	5							1			
t _{pd}	propagation delay	An to Bn or Bn to An; see Fig. 3	[1]								
		V _{CC} = 2.0 V		-	25	90	-	115	-	135	ns
		V _{CC} = 4.5 V		-	9	18	-	23	-	27	ns
		V _{CC} = 5.0 V; C _L = 15 pF		-	7	-	-	-	-	-	ns
		V _{CC} = 6.0 V		-	7	15	-	20	-	23	ns
t _{en}	enable time	OE to An or Bn; see Fig. 4	[2]								
		V _{CC} = 2.0 V		-	30	150	-	190	-	225	ns
		V _{CC} = 4.5 V		-	11	30	-	38	-	45	ns
		V _{CC} = 6.0 V		-	9	26	-	33	-	38	ns
t _{dis}	disable time	OE to An or Bn; see Fig. 4	[3]								
		V _{CC} = 2.0 V		-	41	150	-	190	-	225	ns
		V _{CC} = 4.5 V		-	15	30	-	38	-	45	ns
		V _{CC} = 6.0 V		-	12	26	-	33	-	38	ns
t _t	transition time	see Fig. 3	[4]								
		V _{CC} = 2.0 V		-	14	60	-	75	-	90	ns
		V _{CC} = 4.5 V		-	5	12	-	15	-	18	ns
		V _{CC} = 6.0 V		-	4	10	-	13	-	15	ns
C _{PD}	power dissipation capacitance	per transceiver; V _I = GND to V _{CC}	[5]	-	30	-	-	-	-	-	pF
74HCT2	45										
t _{pd}	propagation delay	An to Bn or Bn to An; see Fig. 3	[1]								
		V _{CC} = 4.5 V		-	12	22	-	28	-	33	ns
		$V_{CC} = 5.0 \text{ V}; C_L = 15 \text{ pF}$		-	10	-	-	-	-	-	ns
t _{en}	enable time	OE to An or Bn; see Fig. 4	[2]	-	16	30	-	38	-	45	ns
t _{dis}	disable time	OE to An or Bn; see Fig. 4	[3]	-	16	30	-	38	-	45	ns
t _t	transition time	V _{CC} = 4.5 V; see <u>Fig. 3</u>	[4]	-	5	12	-	15	-	18	ns
C _{PD}	power dissipation capacitance	per transceiver; V _I = GND to V _{CC} - 1.5 V	[5]	-	30	-	-	-	-	-	pF

^[1] t_{pd} is the same as t_{PHL} and t_{PLH} .

C_L = output load capacitance in pF;

 V_{CC} = supply voltage in V;

N = number of inputs switching;

 $\sum (C_L \times V_{CC}^2 \times f_0) = \text{sum of outputs.}$

 t_{en} is the same as t_{PZH} and t_{PZL} .

t_{dis} is the same as t_{PHZ} and t_{PLZ}.

 t_t is the same as t_{THL} and t_{TLH} . C_{PD} is used to determine the dynamic power dissipation (P_D in μW): $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \sum (C_L \times V_{CC}^2 \times f_o)$ where: f_i = input frequency in MHz; f_o = output frequency in MHz;

10.1. Waveforms and test circuit

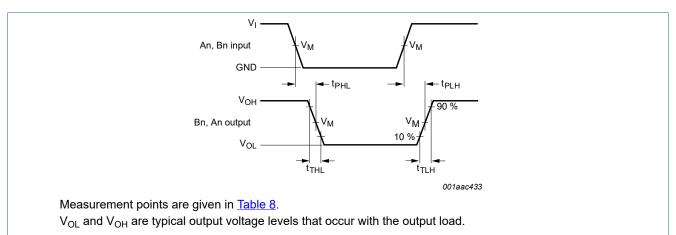


Fig. 3. Input (An, Bn) to output (Bn, An) propagation delays and output transition times

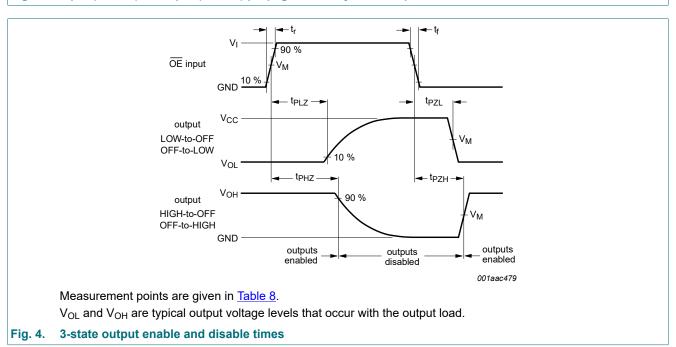
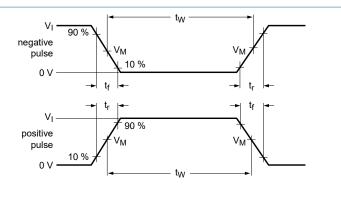
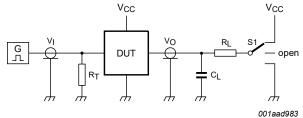


Table 8. Measurement points

Туре	Input	Output						
	V _M	V _M						
74HC245	0.5 × V _{CC}	0.5 × V _{CC}						
74HCT245	1.3 V	1.3 V						





Test data is given in Table 9.

Definitions test circuit:

 R_T = Termination resistance should be equal to output impedance Z_o of the pulse generator;

C_L = Load capacitance including jig and probe capacitance;

R_L = Load resistance;

S1 = Test selection switch.

Fig. 5. Test circuit for measuring switching times

Table 9. Test data

Туре	Input		Load		S1 position		
	V_{l}	t _r , t _f	CL	R_L	t _{PHL} , t _{PLH}	t _{PZH} , t _{PHZ}	t_{PZL}, t_{PLZ}
74HC245	V _{CC}	6 ns	15 pF, 50 pF	1 kΩ	open	GND	V _{CC}
74HCT245	3 V	6 ns	15 pF, 50 pF	1 kΩ	open	GND	V _{CC}

11. Package outline

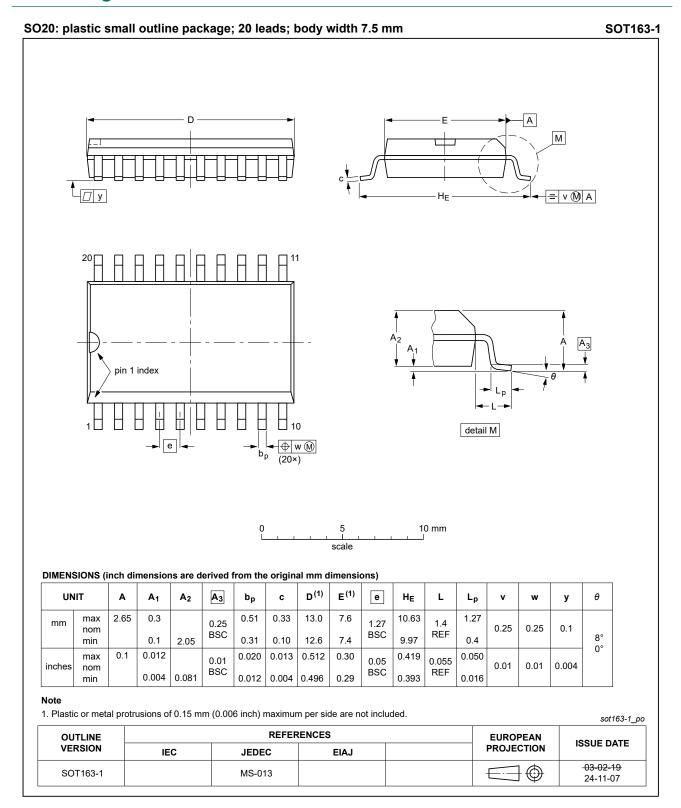


Fig. 6. Package outline SOT163-1 (SO20)

TSSOP20: plastic thin shrink small outline package; 20 leads; body width 4.4 mm

SOT360-1

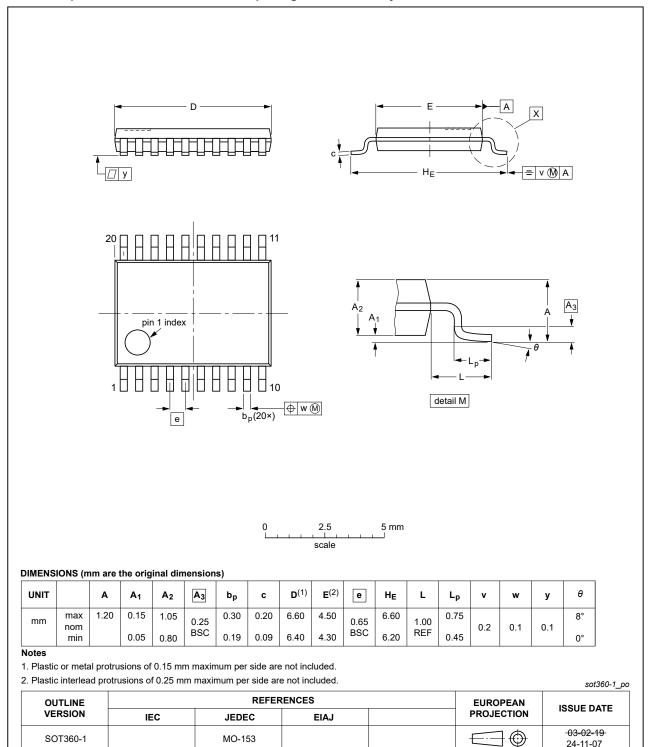


Fig. 7. Package outline SOT360-1 (TSSOP20)

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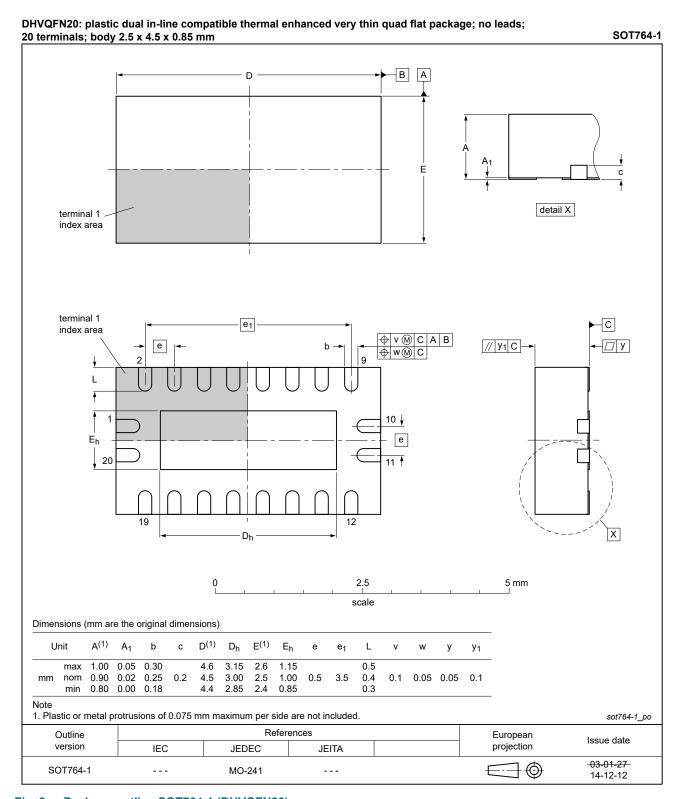


Fig. 8. Package outline SOT764-1 (DHVQFN20)

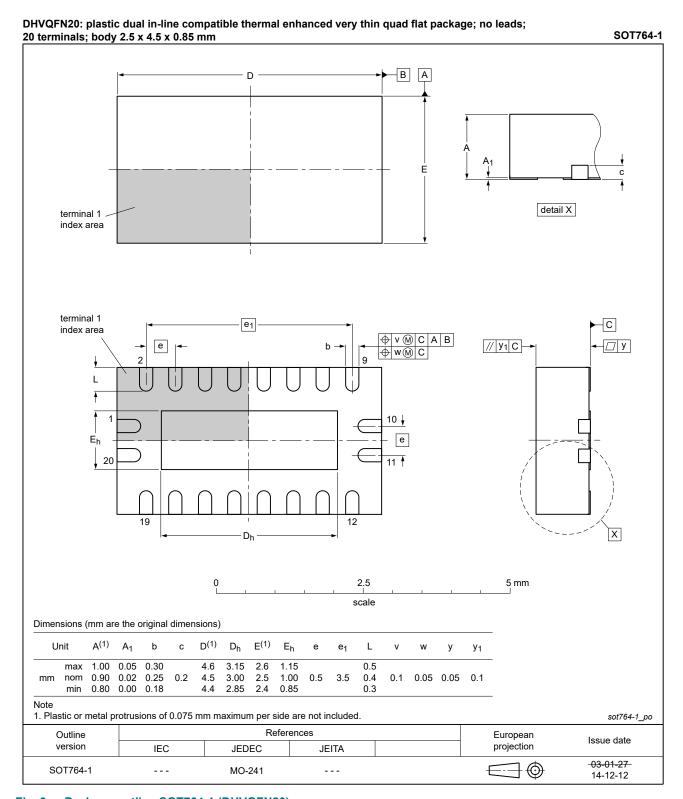


Fig. 9. Package outline SOT764-1 (DHVQFN20)

12. Abbreviations

Table 10. Abbreviations

Acronym	Description
ANSI	American National Standards Institute
CDM	Charged Device Model
CMOS	Complementary Metal Oxide Semiconductor
DUT	Device Under Test
ESD	ElectroStatic Discharge
ESDA	ElectroStatic Discharge Association
НВМ	Human Body Model
JEDEC	Joint Electron Device Engineering Council
TTL	Transistor-Transistor Logic

13. Revision history

Table 11. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes					
74HC_HCT245 v.9	20250509	Product data sheet	-	74HC_HCT245 v.8					
Modifications:	Type number	ers 74HC245BZ and 74HC	T245BZ (SOT802	0-1/DHXQFN20) added.					
74HC_HCT245 v.8	20241129	Product data sheet	-	74HC_HCT245 v.7					
Modifications:		• Fig. 6 and Fig. 7: Aligned SO and TSSOP package outline drawings to JEDEC MS-013 and MO-153.							
74HC_HCT245 v.7	20240805	Product data sheet	-	74HC_HCT245 v.6					
Modifications:	Section 2: E	SD specification updated	according to the la	atest JEDEC standard.					
74HC_HCT245 v.6	20210906	Product data sheet	-	74HC_HCT245 v.5					
Modifications:	* *	 Types 74HC245DB and 74HCT245DB (SOT339-1) were removed. Section 2 updated. 							
74HC_HCT245 v.5	20200714	Product data sheet	-	74HC_HCT245 v.4					
Modifications:	guidelines o Legal texts	of this data sheet has beer of Nexperia. have been adapted to the r rating values for P _{tot} total p	new company nar	ne where appropriate.					
74HC_HCT245 v.4	20160226	Product data sheet	-	74HC_HCT245 v.3					
Modifications:	Type number	ers 74HC245N and 74HCT	245N (SOT146-1) removed.					
74HC_HCT245 v.3	20050131	Product data sheet	-	74HC_HCT245_CNV v.2					
Modifications:	 The format of this data sheet is redesigned to comply with the new presentation and information standard of Philips Semiconductors Section 3 "Ordering information", Section 5 "Pinning information" and Section 11 "Package outline" are modified to include the DHVQFN20 package. 								
74HC_HCT245_CNV v.2	19930930	Product specification	-	-					

14. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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- [2] The term 'short data sheet' is explained in section "Definitions".
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